DRD2960Y40

Rectifier Diode

DS5983-2 June 13 (LN30617)

FEATURES

- Double Side Cooling
- High Surge Capability

APPLICATIONS

- Rectification
- Free-wheel Diode
- DC Motor Control
- Power Supplies
- Welding
- Battery Chargers

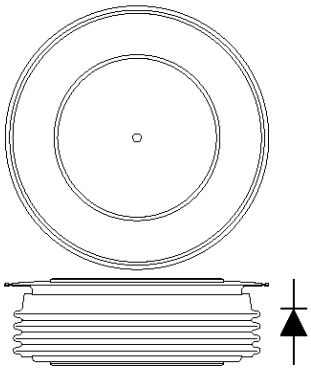
KEY PARAMETERS

V_{RRM}	**4000V**
$I_{F(AV)}$	**2956A**
I_{FSM}	**62500A**

VOLTAGE RATINGS

Part and Ordering Number	Repetitive Peak Voltages V_{RRM} V	Conditions
DRD2960Y40	4000	$V_{RSM} = V_{RRM}+100V$
DRD2960Y39	3900	
DRD2960Y38	3800	
DRD2960Y37	3700	
DRD2960Y36	3600	
DRD2960Y35	3500	

Lower voltage grades available.



Outline type code: Y

(See Package Details for further information)

Fig. 1 Package outlines

ORDERING INFORMATION

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

DRD2960Y37 for a 3700V device in a Y outline

Note: Please use the complete part number when ordering and quote this number in any future correspondence relating to your order.

CURRENT RATINGS

T_{case} = 75°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
Double Side Cooled				
$I_{F(AV)}$	Mean forward current	Half wave resistive load	3830	A
$I_{F(RMS)}$	RMS value	-	6016	A
I_F	Continuous (direct) on-state current	-	5597	A
Single Side Cooled (Anode side)				
$I_{F(AV)}$	Mean forward current	Half wave resistive load	2525	A
$I_{F(RMS)}$	RMS value	-	3966	A
I_F	Continuous (direct) on-state current	-	3421	A

T_{case} = 100°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
Double Side Cooled				
$I_{F(AV)}$	Mean forward current	Half wave resistive load	2956	A
$I_{F(RMS)}$	RMS value	-	4643	A
I_F	Continuous (direct) on-state current	-	4218	A
Single Side Cooled (Anode side)				
$I_{F(AV)}$	Mean forward current	Half wave resistive load	1913	A
$I_{F(RMS)}$	RMS value	-	3005	A
I_F	Continuous (direct) on-state current	-	2514	A

SURGE RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
I_{FSM}	Surge (non-repetitive) on-state current	10ms half sine, T_{case} = 150°C	50.0	kA
I^2t	I^2t for fusing	V_R = 50% V_{RRM} - ¼ sine	12.5	MA^2s
I_{FSM}	Surge (non-repetitive) on-state current	10ms half sine, T_{case} = 150°C	62.5	kA
I^2t	I^2t for fusing	V_R = 0	19.6	MA^2s

THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Conditions		Min.	Max.	Units
$R_{th(j-c)}$	Thermal resistance – junction to case	Double side cooled	DC	-	0.0095	°C/W
		Single side cooled	Anode DC	-	0.019	°C/W
			Cathode DC	-	0.019	°C/W
$R_{th(c-h)}$	Thermal resistance – case to heatsink	Clamping force 43kN	Double side	-	0.002	°C/W
		(with mounting compound)	Single side	-	0.004	°C/W
T_{vj}	Virtual junction temperature	On-state (conducting)		-	160	°C
		Reverse (blocking)		-	150	°C
T_{stg}	Storage temperature range			-55	150	°C
F_m	Clamping force			38.0	47.0	kN

CHARACTERISTICS

Symbol	Parameter	Test Conditions	Min.	Max.	Units
V_{FM}	Forward voltage	At 3000A peak, T_{case} = 25°C	-	1.15	V
I_{RM}	Peak reverse current	At V_{DRM}, T_{case} = 150°C	-	250	mA
Q_S	Total stored charge	I_F = 2000A, dI_{RR}/dt =3A/µs	-	5000	µC
I_{rr}	Peak reverse recovery current	T_{case} = 150°C, V_R =100V	-	150	A
V_{TO}	Threshold voltage	At T_{vj} = 150°C	-	0.75	V
r_T	Slope resistance	At T_{vj} = 150°C	-	0.118	mΩ

CURVES

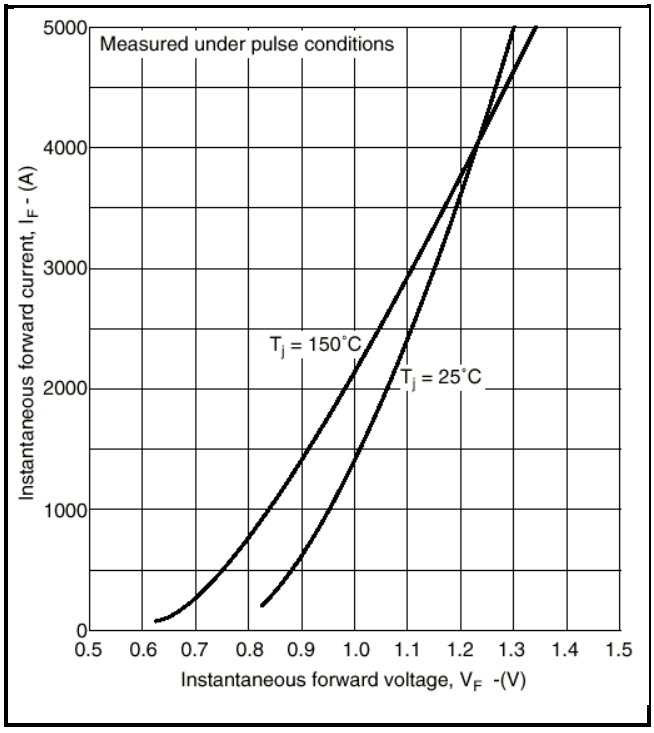


Fig.2 Maximum (limit) on-state characteristics

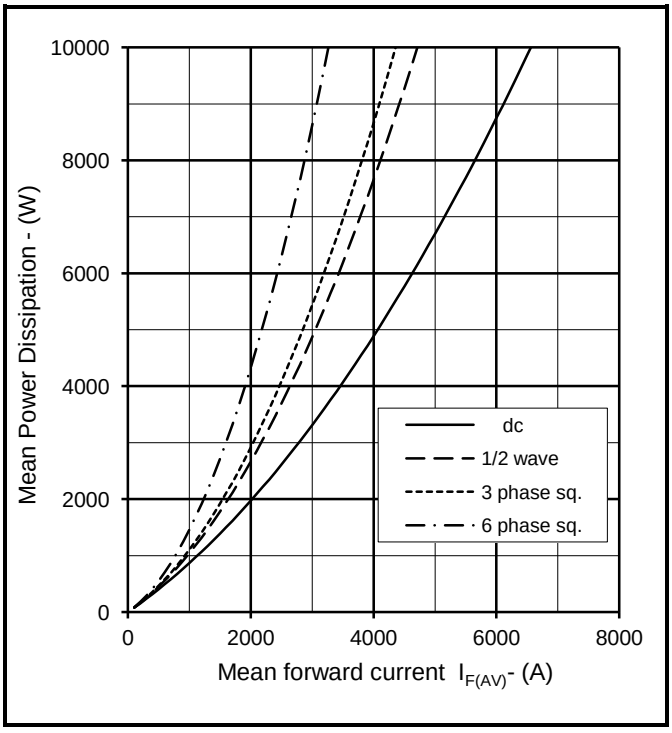


Fig.3 Dissipation curves

V_{TM} EQUATION

$V_{TM} = A + B\ln(I_T) + C.I_T + D.\sqrt{I_T}$

Where A = - 0.15357
B = 0.177571
C = 0.000179
D = - 0.01294

these values are valid for T_j = 150°C for I_F 500A to 5000A

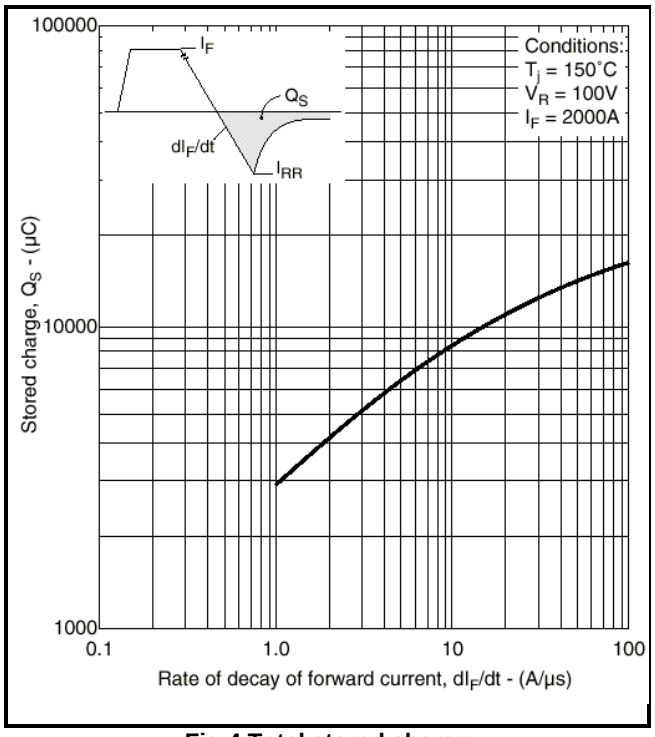


Fig.4 Total stored charge

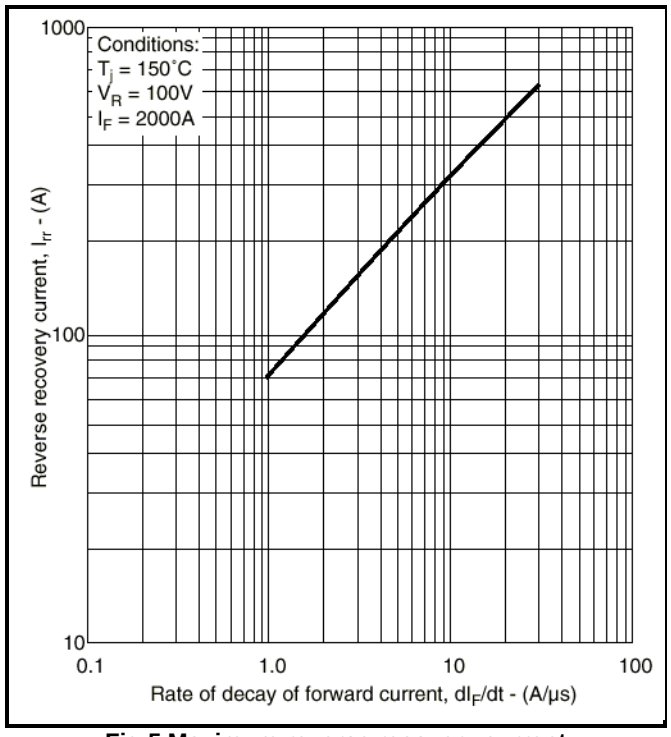


Fig.5 Maximum reverse recovery current

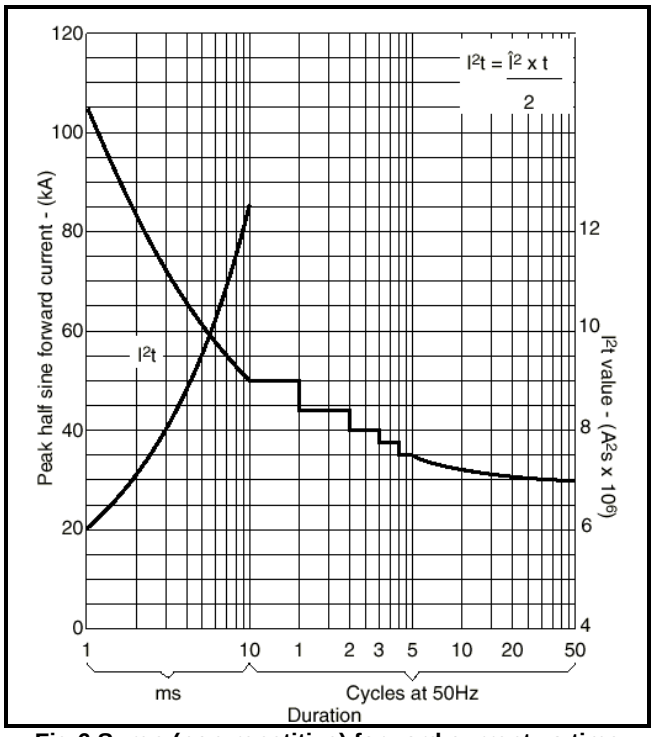


Fig.6 Surge (non-repetitive) forward current vs time (with 50% V_{RRM} at T_{case} 150°C)

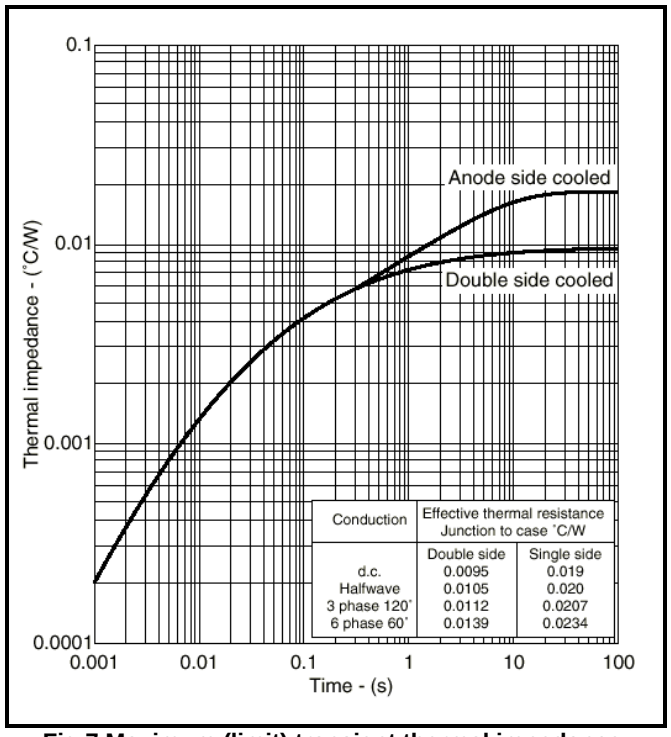
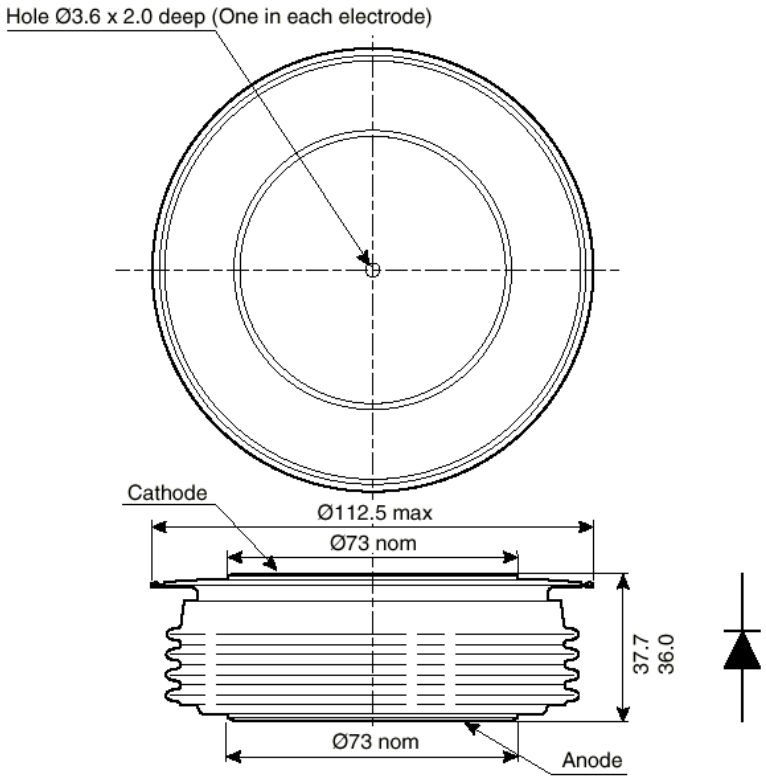


Fig.7 Maximum (limit) transient thermal impedance-junction to case

PACKAGE DETAILS

For further package information, please contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.



Normal weight: 1600g
Clamping force: 43kN±10%

Package outline type code:Y

Note:
Some packages may be supplied with gate and or tags.

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HEADQUARTERS OPERATIONS

DYNEX SEMICONDUCTOR LIMITED
Doddington Road, Lincoln, Lincolnshire, LN6 3LF
United Kingdom.
Phone: +44 (0) 1522 500500
Fax: +44 (0) 1522 500550
Web: http://www.dynexsemi.com

CUSTOMER SERVICE

Phone: +44 (0) 1522 502753 / 502901
Fax: +44 (0) 1522 500020
e-mail: power_solutions@dynexsemi.com

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